

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	TLE75004-EPD	**Issued**	27. April 2022
MA#	MA005739299		
Package	PG-TSDSO-14-41	**Weight***	64.83 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.299	2.00	2.00	20033	20033
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		144	
	non noble metal	zinc	7440-66-6	0.037	0.06		575	
	non noble metal	iron	7439-89-6	0.745	1.15		11490	
	non noble metal	copper	7440-50-8	30.247	46.66	47.88	466550	478759
wire	non noble metal	copper	7440-50-8	0.484	0.75	0.75	7461	7461
encapsulation	organic material	carbon black	1333-86-4	0.087	0.13		1338	
	plastics	epoxy resin	-	3.382	5.22		52169	
	inorganic material	silicondioxide	60676-86-0	25.439	39.24	44.59	392384	445891
leadfinish	non noble metal	tin	7440-31-5	1.642	2.53	2.53	25322	25322
plating	noble metal	silver	7440-22-4	0.823	1.27	1.27	12688	12688
glue	plastics	epoxy resin	-	0.112	0.17		1723	
	noble metal	silver	7440-22-4	0.527	0.81	0.98	8123	9846
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com